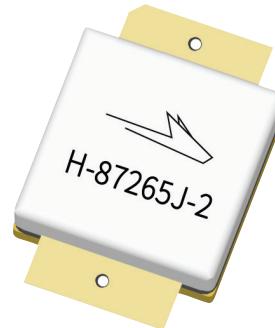


# GTVA262711FA

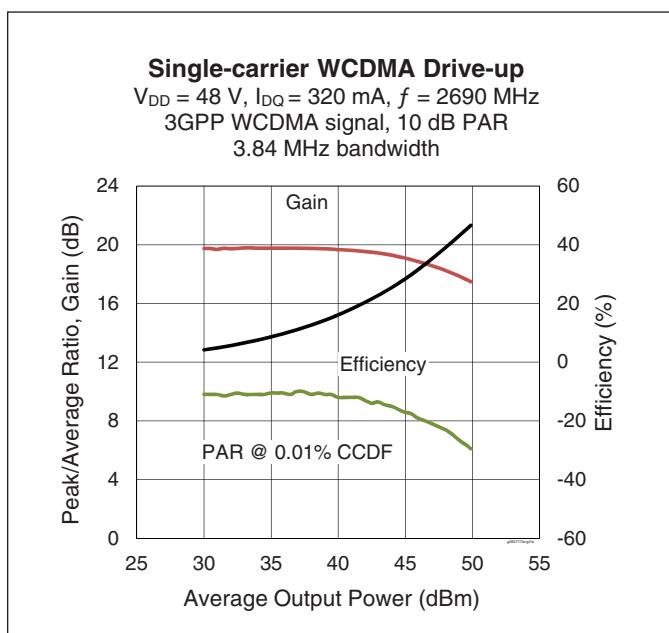
Thermally-Enhanced High Power RF GaN on SiC HEMT  
300 W, 48 V, 2620 – 2690 MHz



Package Types: H-87265J-2

## Description

The GTVA262711FA is a 300-watt ( $P_{3dB}$ ) GaN on SiC high electron mobility transistor (HEMT) for use in multi-standard cellular power amplifier applications. It features input matching, high efficiency, and a thermally-enhanced package with earless flange.



## Features

- GaN on SiC HEMT technology
- Input matched
- Typical pulsed CW performance: 10  $\mu$ s pulse width, 10% duty cycle, 2690 MHz, 48 V
  - Output power at  $P_{3dB}$  = 300 W
  - Efficiency = 62%
  - Gain = 19.1 dB
- Human Body Model Class 1B (per ANSI/ESDA/JEDEC JS-001)
- Capable of handling 10:1 VSWR @48 V, 70 W (CW)
- Pb-free and RoHS-compliant

## RF Characteristics

### Single-carrier WCDMA Specifications (tested in Wolfspeed production test fixture)

$V_{DD} = 48$  V,  $I_{DQ} = 320$  mA,  $P_{OUT} = 70$  W avg,  $f = 2690$  MHz. 3GPP WDMA signal, 3.84 MHz channel bandwidth, peak/average = 10 dB @ 0.01% CCDF

Characteristic	Symbol	Min.	Typ.	Max.	Unit
Gain	$G_{ps}$	16	18	—	dB
Drain Efficiency	$\eta_D$	38	38.5	—	%
Adjacent Channel Power Ratio	ACPR	—	-27.5	-25	dBc
Output PAR @ 0.01% CCDF	OPAR	5.7	6.3	—	dB

Note:

All published data at  $T_{CASE} = 25^\circ\text{C}$  unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!





## DC Characteristics

Characteristic	Symbol	Min.	Typ.	Max.	Unit	Conditions
Drain-source Breakdown Voltage	$V_{BR(DSS)}$	150	—	—	V	$V_{GS} = -8\text{ V}$ , $I_D = 32\text{ mA}$
Drain-source Leakage Current	$I_{DSS}$	—	—	4.5	mA	$V_{GS} = -8\text{ V}$ , $V_{DS} = 10\text{ V}$
Gate Threshold Voltage	$V_{GS(th)}$	-3.8	-3.0	-2.3	V	$V_{DS} = 10\text{ V}$ , $I_D = 32\text{ mA}$

## Recommended Operating Conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Operating Voltage	$V_{DD}$	0	—	50	V	$V_{DS} = 50\text{ V}$ , $I_D = 320\text{ mA}$
Gate Quiescent Voltage	$V_{GS(Q)}$	—	-3.0	—		

Gate Quiescent Voltage's ( $V_{GS(Q)}$ ) range can be estimated by adding +0.1 V to the Gate Threshold Voltage ( $V_{GS(th)}$ ) range.

## Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-source Voltage	$V_{DSS}$	125	V
Gate-source Voltage	$V_{GS}$	-10 to +2	
Gate Current	$I_G$	32	mA
Drain Current	$I_D$	12	A
Junction Temperature	$T_J$	225	°C
Storage Temperature Range	$T_{STG}$	-65 to +150	

Operation above the maximum values listed here may cause permanent damage. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the component. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For reliable continuous operation, the device should be operated within the operating voltage range ( $V_{DD}$ ) specified above.

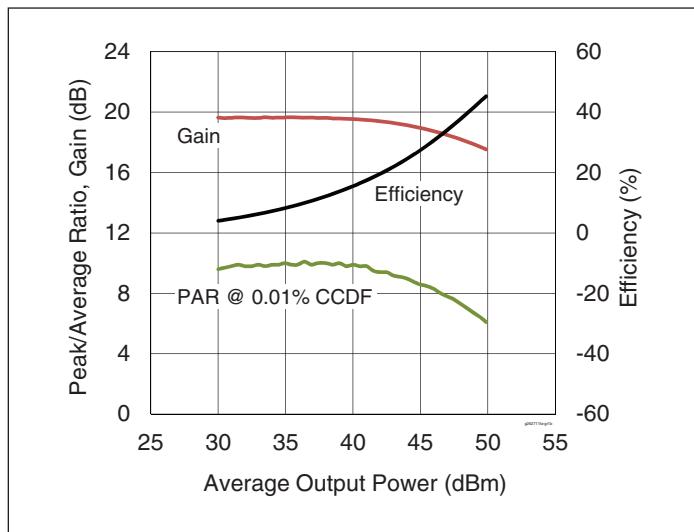
## Thermal Characteristics

Characteristic	Symbol	Value	Unit	Conditions
Thermal Resistance	$R_{\theta JC}$	1.0	°C/W	$T_{CASE} = 70\text{ °C}$ , 70 W (CW), $V_{DD} = 48\text{ V}$ , $I_{DQ} = 320\text{ mA}$ , 2690 MHz

## Ordering Information

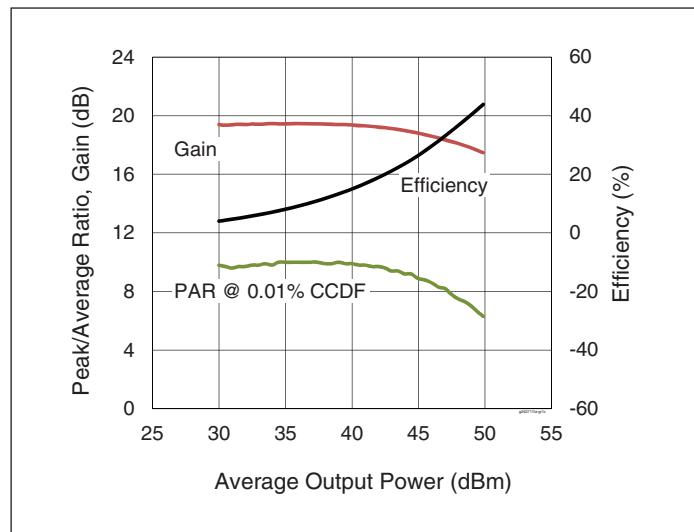
Type and Version	Order Code	Package	Shipping
GTVA262711FA V2 R0	GTVA262711FA-V2-R0	H-87265J-2	Tape & Reel, 50 pcs
GTVA262711FA V2 R2	GTVA262711FA-V2-R2	H-87265J-2	Tape & Reel, 250 pcs

## Typical Performance (data taken in Wolfspeed production test fixture)



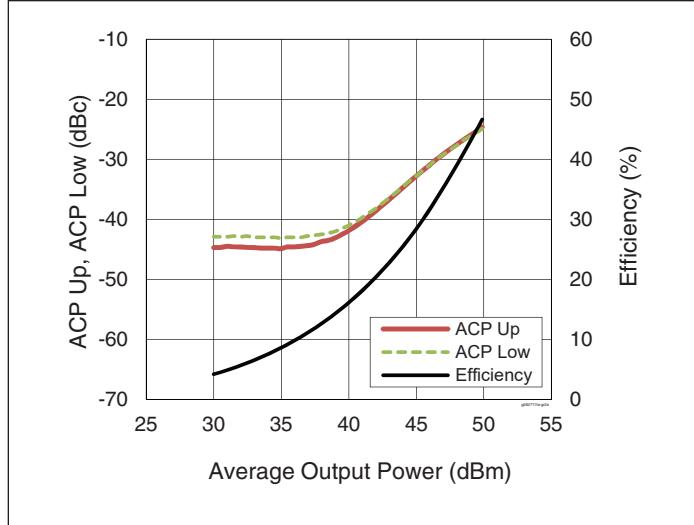
**Figure 1.** Single-carrier WCDMA Drive-up

$V_{DD} = 48 \text{ V}$ ,  $I_{DD} = 320 \text{ mA}$ ,  $f = 2655 \text{ MHz}$ ,  
3GPP WCDMA signal, 10 dB PAR,  
3.84 MHz bandwidth



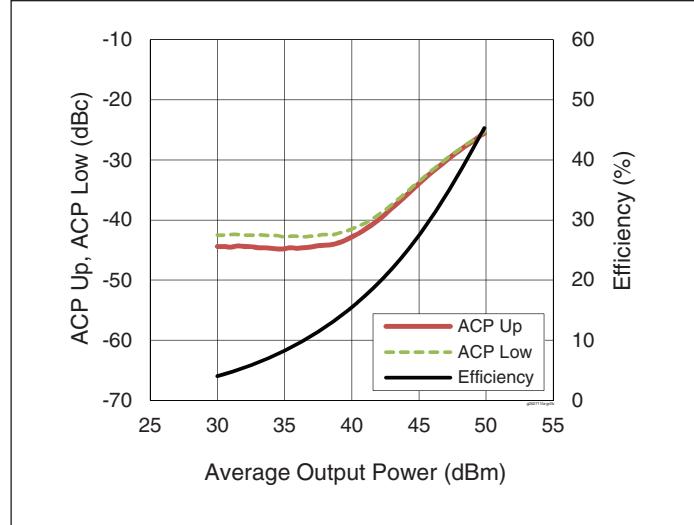
**Figure 2.** Single-carrier WCDMA Drive-up

$V_{DD} = 48 \text{ V}$ ,  $I_{DD} = 320 \text{ mA}$ ,  $f = 2620 \text{ MHz}$ ,  
3GPP WCDMA signal, 10 dB PAR,  
3.84 MHz bandwidth



**Figure 3.** Single-carrier WCDMA Drive-up

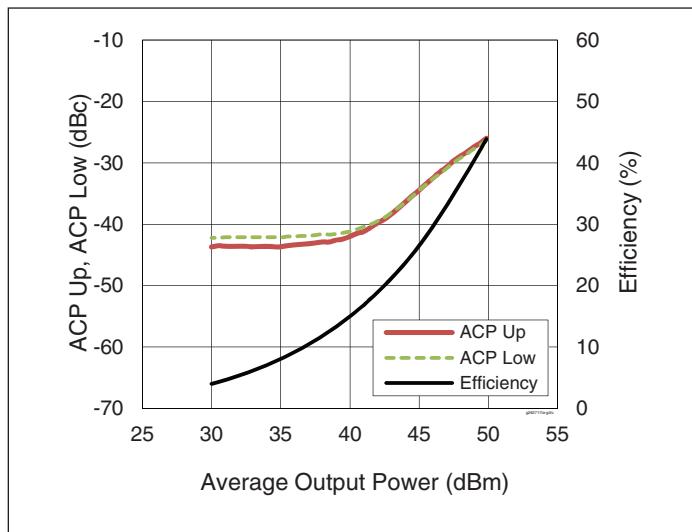
$V_{DD} = 48 \text{ V}$ ,  $I_{DD} = 320 \text{ mA}$ ,  $f = 2690 \text{ MHz}$ ,  
3GPP WCDMA signal, 10 dB PAR,  
3.84 MHz bandwidth



**Figure 4.** Single-carrier WCDMA Drive-up

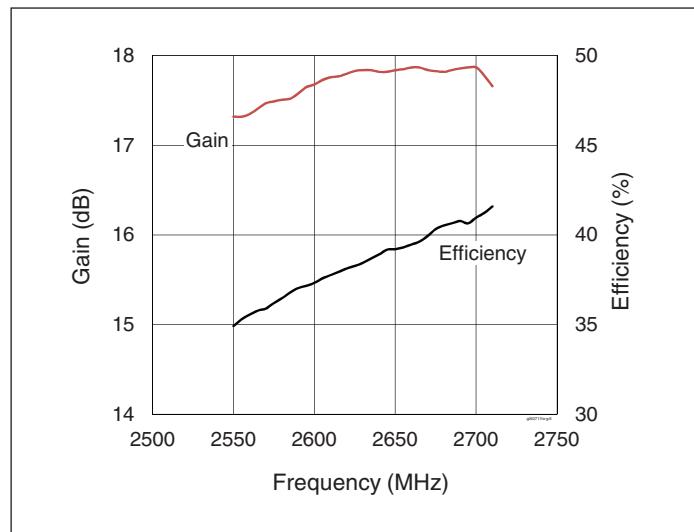
$V_{DD} = 48 \text{ V}$ ,  $I_{DD} = 320 \text{ mA}$ ,  $f = 2655 \text{ MHz}$ ,  
3GPP WCDMA signal, 10 dB PAR,  
3.84 MHz bandwidth

## Typical Performance (cont.)



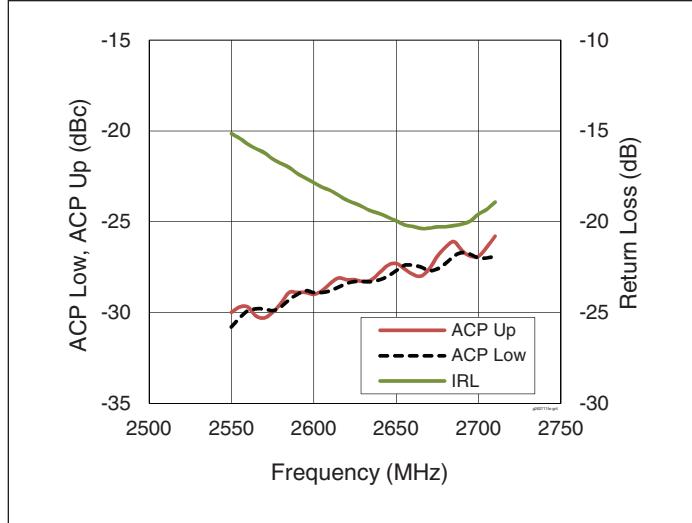
**Figure 5.** Single-carrier WCDMA Drive-up

$V_{DD} = 48$  V,  $I_{DQ} = 320$  mA,  $f = 2620$  MHz,  
3GPP WCDMA signal, 10 dB PAR,  
3.84 MHz bandwidth



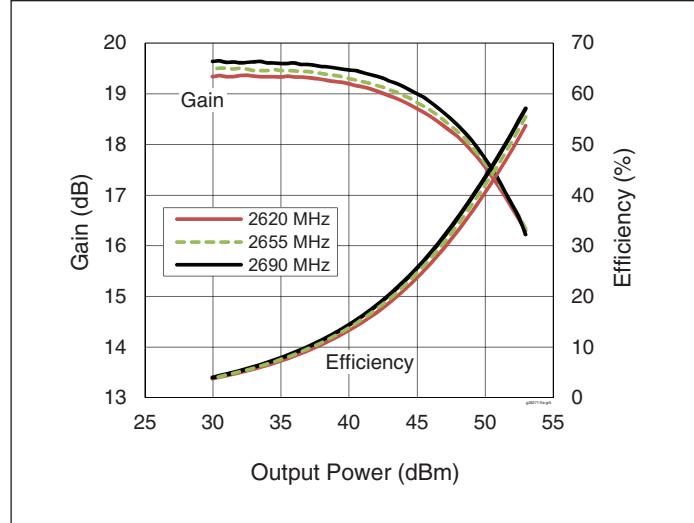
**Figure 6.** Single-carrier WCDMA Broadband

$V_{DD} = 48$  V,  $I_{DQ} = 320$  mA,  $P_{OUT} = 48.45$  dBm,  
3GPP WCDMA signal, 10 dB PAR



**Figure 7.** Single-carrier WCDMA Broadband

$V_{DD} = 48$  V,  $I_{DQ} = 320$  mA,  $P_{OUT} = 48.45$  dBm  
3GPP WCDMA signal, 10 dB PAR

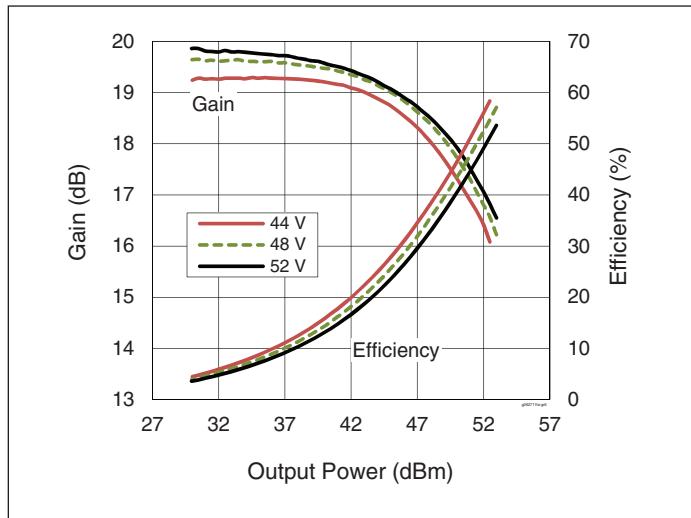


**Figure 8.** CW Performance

$V_{DD} = 48$  V,  $I_{DQ} = 320$  mA

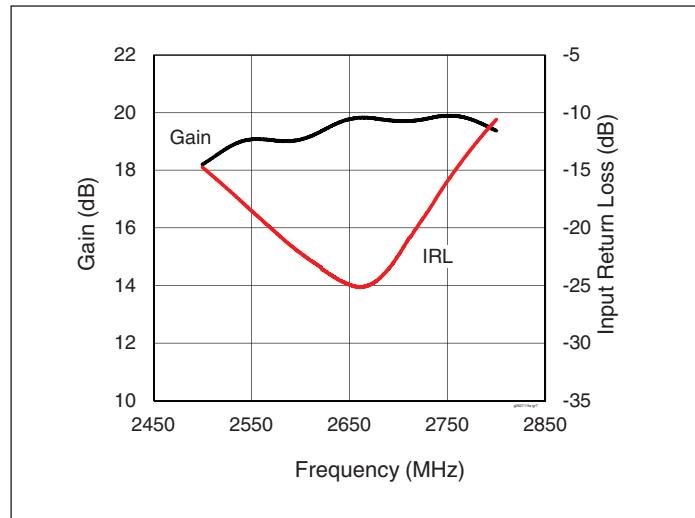


## Typical Performance (cont.)



**Figure 9.** CW Performance at various  $V_{DD}$

$I_{DQ} = 320 \text{ mA}$ ,  $f = 2690 \text{ MHz}$   
(series show supply voltage)



**Figure 10.** CW Performance Small Signal Gain & Input Return Loss

$V_{DD} = 48 \text{ V}$ ,  $I_{DQ} = 320 \text{ mA}$

## Load Pull Performance

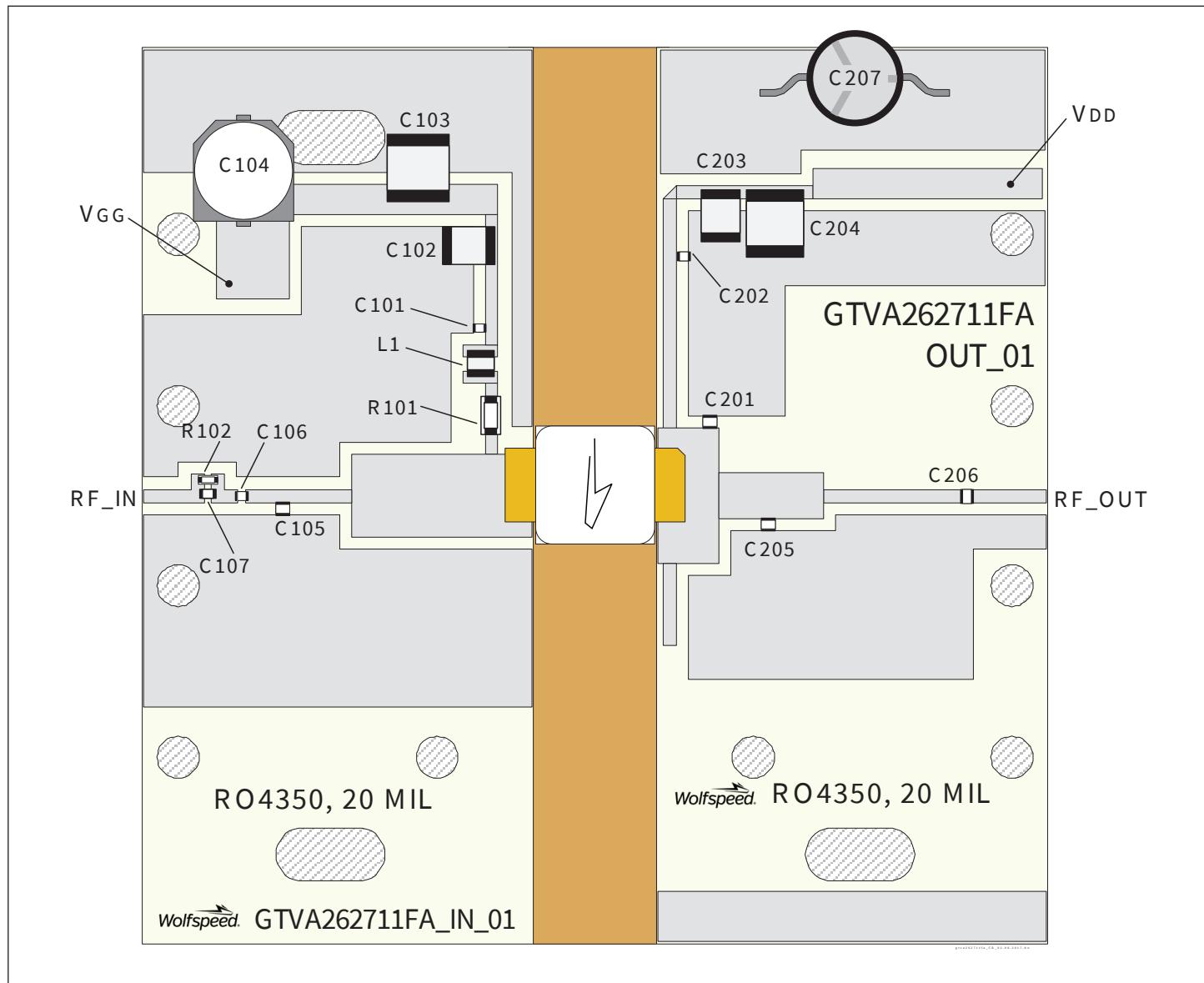
**Pulsed CW signal** – 10  $\mu\text{sec}$ , 10% duty cycle; 48 V, 320 mA

Class AB		$P_{3\text{dB}}$										
		Max Output Power				Max Drain Efficiency						
Freq [MHz]	$Z_s [\Omega]$	$Z_{l2f_0} [\Omega]$	$Z_l [\Omega]$	Gain [dB]	$P_{3\text{dB}} [\text{dBm}]$	$P_{3\text{dB}} [\text{W}]$	$\eta_D [\%]$	$Z_l [\Omega]$	Gain [dB]	$P_{3\text{dB}} [\text{dBm}]$	$P_{3\text{dB}} [\text{W}]$	$\eta_D [\%]$
2620	$8.3 - j4.7$	$1.2 + j0$	$2.75 - j4.56$	15.5	55.48	353	60.7	$2.5 - j2.94$	16.8	54.52	283	68.0
2655	$6.7 - j4.3$	$1.3 + j0$	$2.79 - j4.59$	15.5	55.46	352	60.8	$2.14 - j2.85$	17.2	53.83	242	66.3
2690	$5.6 - j5.2$	$1.2 + j0$	$2.85 - j4.50$	15.4	55.43	349	60.2	$2.46 - j3.03$	16.7	54.38	274	65.9

## Evaluation Board, 2620 to 2690 MHz

Evaluation Board Part Number	LTN/GTVA262711FA-V2
PCB Information	Rogers 4350, 0.508 mm [.020"] thick, 2 oz. copper, $\epsilon_r = 3.66$

Find Gerber files for this test fixture on the Wolfspeed Web site at [www.wolfspeed.com/RF](http://www.wolfspeed.com/RF)



Reference circuit assembly diagram (not to scale)



## Components Information

Component	Description	Manufacturer	P/N
<b>Input</b>			
C101	Capacitor, 33 pF	ATC	ATC800A330JT250T
C102	Capacitor, 1 µF	TDK Corporation	C4532X7R2A105M230KA
C103	Capacitor, 10 µF	TDK Corporation	C5750X5R1H106K230KA
C104	Capacitor, 100 µF	Panasonic Electronic Components	EEV-HD1V101P
C105	Capacitor, 1.8 pF	ATC	ATC800A1R8CT250T
C106, C107	Capacitor, 12 pF	ATC	ATC800A120JT250T
L1	Inductor, 22 nH	ATC	0805WL220JT
R101	Resistor, 5.6 ohms	Panasonic Electronic Components	ERJ-8RQJ5R6V
R102	Resistor, 10 ohms	Panasonic Electronic Components	ERJ-3GEYJ100V
<b>Output</b>			
C201	Capacitor, 1.1 pF	ATC	ATC800A1R1CT250T
C202, C206	Capacitor, 12 pF	ATC	ATC800A120JT250T
C203	Capacitor, 1 µF	TDK Corporation	C4532X7R2A105M230KA
C204	Capacitor, 10 µF	TDK Corporation	C5750X5R1H106K230KA
C205	Capacitor, 0.4 pF	ATC	ATC800A0R4CT250T
C207	Capacitor, 220 µF	Panasonic Electronic Components	ECA-2AHG221

## Bias Sequencing

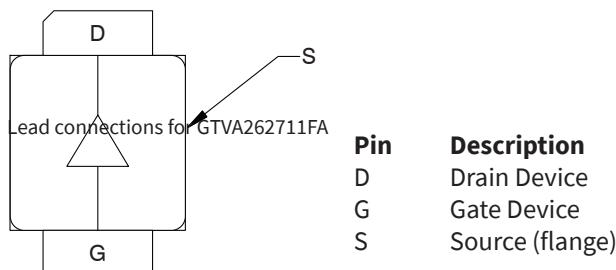
### Bias On

1. Ensure RF is turned off
2. Apply pinch-off voltage of -5 V to the gate
3. Apply nominal drain voltage
4. Bias gate to desired quiescent drain current
5. Apply RF

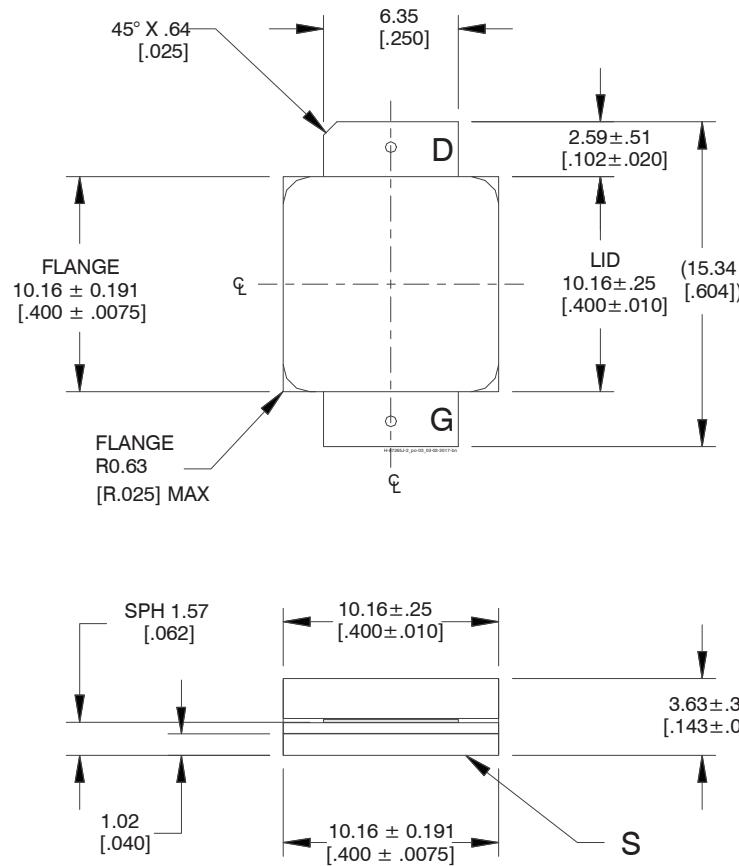
### Bias Off

1. Turn RF off
2. Apply pinch-off voltage to the gate
3. Turn-off drain voltage
4. Turn-off gate voltage

## Pinout Diagram (top view)



## Package Outline Specifications – Package H-87265J-2



### Diagram Notes—unless otherwise specified:

1. Interpret dimensions and tolerances per ASME Y14.5M-1994.
2. Primary dimensions are mm. Alternate dimensions are inches.
3. All tolerances  $\pm 0.127$  [.005] unless specified otherwise.
4. Pins: D – drain; G – gate; S – source.
5. Lead thickness:  $0.13 \pm 0.05$  mm [.005 ± .002 inch].
6. Gold plating thickness:  $1.14 \pm 0.38$  micron [45 ± 15 microinch].

**For more information, please contact:**

4600 Silicon Drive  
Durham, NC 27703 USA  
Tel: +1.919.313.5300  
[www.wolfspeed.com/RF](http://www.wolfspeed.com/RF)

Sales Contact  
[RFSales@wolfspeed.com](mailto:RFSales@wolfspeed.com)

RF Product Marketing Contact  
[RFMarketing@wolfspeed.com](mailto:RFMarketing@wolfspeed.com)

---

## Notes & Disclaimer

Specifications are subject to change without notice. “Typical” parameters are the average values expected by Wolfspeed in large quantities and are provided for information purposes only. Wolfspeed products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death. No responsibility is assumed by Wolfspeed for any infringement of patents or other rights of third parties which may result from use of the information contained herein. No license is granted by implication or otherwise under any patent or patent rights of Wolfspeed.

© 2022 Wolfspeed, Inc. All rights reserved. Wolfspeed® and the Wolfstreak logo are registered trademarks and the Wolfspeed logo is a trademark of Wolfspeed, Inc.  
PATENT: <https://www.wolfspeed.com/legal/patents>

*The information in this document is subject to change without notice.*